

# FTG for Integrated Core Logic with 133-MHz FSB

#### **Features**

- Maximized EMI suppression using Cypress's Spread Spectrum technology
- Low jitter and tightly controlled clock skew
- Highly integrated device providing clocks required for CPU, core logic, and SDRAM
- Two copies of CPU clock at 66/100/133 MHz
- Thirteen copies of SDRAM clocks at 100/133 MHz
- Five copies of PCI clock compliant to PCI spec 2-1 and capable of driving a maximum load of 40 pF
- One copy of synchronous APIC clock
- Two copies of 48-MHz clock (non-spread spectrum) optimized for USB reference input and video dot clock
- Three copies of 66-MHz fixed clock
- One copy of 14.31818-MHz reference clock
- Power down control
- SMBus interface for turning off unused clocks

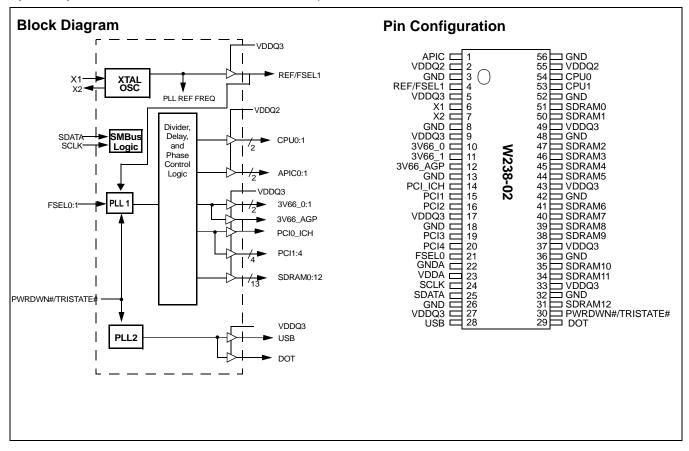
### **Key Specifications**

| C | CPU, SDRAM Outputs Cycle-to-Cycle Jitter: | 250 | ps |
|---|---|-----|----|
| Α | NPIC, 48-MHz, 3V66, PCI Outputs           |     |    |
| С | Cycle-to-Cycle Jitter:                    | 500 | ps |

| APIC, 48-MHz, SDRAM Output Skew: | 250 ps        |
|----------------------------------|---------------|
| CPU, 3V66 Output Skew:           | 175 ps        |
| PCI Output Skew:                 | 500 ps        |
| CPU to SDRAM Skew (@ 133 MHz):   | ±0.5 ns       |
| CPU to SDRAM Skew (@ 100 MHz):   | 4.5 to 5.5 ns |
| CPU to 3V66 Skew (@ 66 MHz):     | 7.0 to 8.0 ns |
| 3V66 to PCI Skew (3V66 lead):    | 1.5 to 3.5 ns |
| PCI to APIC Skew:                | ±0.5 ns       |

Table 1. Pin Selectable Functions

| Tristate# | FSEL1 | FSEL0 | Function     | SDRAM       |
|-----------|-------|-------|--------------|-------------|
| 0         | Х     | 0     | Three -State | Three-State |
| 0         | Х     | 1     | Test         | Test        |
| 1         | 0     | 0     | 66 MHz       | 100 MHz     |
| 1         | 0     | 1     | 100 MHz      | 100 MHz     |
| 1         | 1     | 0     | 133 MHz      | 133 MHz     |
| 1         | 1     | 1     | 133 MHz      | 100 MHz     |





### **Pin Definitions**

| Pin Name              | Pin No.   | Pin<br>Type | Pin Description   |  |
|-----------------------|---|-------------|---|--|
| REF/FSEL1             | 4   | I/O         | <b>Reference Clock/Function Select:</b> 3.3V 14.318-MHz clock output. This pin also serves as a strap option for CPU frequency selection. See <i>Table 1</i> for detailed descriptions.   |  |
| X1                    | 6   | I           | Crystal Input: This pin has dual functions. It can be used as an external 14.318-MHz crystal connection or as an external reference frequency input.  |  |
| X2                    | 7   | I           | <b>Crystal Output:</b> An input connection for an external 14.318-MHz crystal. If using an external reference, this pin must be left unconnected.   |  |
| PCI0_ICH,<br>PCI1:4   | 14, 15, 16, 19,<br>20                                       | 0           | <b>PCI Clock 0 through 4:</b> 3.3V 33-MHz PCI clock outputs. PCI1:4 can be individually turned off via SMBus interface.   |  |
| 3V66_0:1<br>3V66_AGP  | 10, 11, 12  | 0           | 66-MHz Clock Output: 3.3V fixed 66-MHz clock.   |  |
| USB                   | 28  | 0           | USB Clock Output: 3.3V fixed 48-MHz, non-spread spectrum USB clock outputs.   |  |
| DOT                   | 29  | 0           | Dot Clock Output: 3.3V 48-MHz, non-spread spectrum signal.  |  |
| FSEL0                 | 21  | I           | <b>Clock Function Selection Pins:</b> LVTTL-compatible input (latched) to select device functions. See <i>Table 1</i> for detailed descriptions. This is a latched input. The status of this pin will be ignore after the internal POR.   |  |
| PWRDWN#/<br>TRISTATE# | 30  | I           | TRISTATE#/PWRDWN#: During power-up, this pin defaults to the PWRDWN# input function. This pin can be configured as the TRISTATE# input function by control register at Byte[3], Bit[1]. This input can be used as the VTT_PWRGD input to support Intel® VRM 8.5 implementation. |  |
| CPU0:1                | 54, 53  | 0           | <b>CPU Clock Outputs:</b> Clock outputs for the host bus interface and integrated test port. Output frequencies run at 66 MHz, 100 MHz, or 133 MHz, depending on the configuration of FSEL0:1 and TRISTATE#. Voltage swing set by V <sub>DDQ2</sub> .                           |  |
| SDRAM0:12             | 51, 50, 47, 46,<br>45, 44, 41, 40,<br>39, 38, 35, 34,<br>31 | 0           | <b>SDRAM Clock Outputs:</b> 3.3V outputs running to 133 MHz. SDRAM0:7 can be individually turned off via SMBus interface.   |  |
| APIC                  | 1   | 0           | <b>Synchronous APIC Clock Outputs:</b> Clock outputs running synchronous with the PCI clock outputs (33 MHz). Voltage swing set by V <sub>DDQ2</sub> .  |  |
| SDATA                 | 25  | I/O         | Data pin for SMBus circuitry.   |  |
| SCLK                  | 24  | I           | Clock pin for SMBus circuitry.  |  |
| VDDQ3                 | 5, 9, 17, 27, 33,<br>37, 43, 49                             | Р           | <b>3.3V Power Connection:</b> Power supply for SDRAM output buffers, PCI output buffers, 3V66 output buffers, reference output buffers, and 48-MHz output buffers. Connect to 3.3V.   |  |
| VDDA                  | 23  | 0           | <b>3.3V Power Connection:</b> Power supply for core logic, PLL circuitry. Connect to 3.3V.  |  |
| VDDQ2                 | 2, 55   | Р           | <b>2.5V Power Connection:</b> Power supply for IOAPIC and CPU output buffers. Connect to 2.5V or 3.3V.  |  |
| GNDA                  | 22  | G           | Ground Connections: Ground for core logic, PLL circuitry.   |  |
| GND                   | 3, 8, 13, 18, 26,<br>32, 36, 42, 48,<br>52, 56              | G           | <b>Ground Connections:</b> Connect all ground pins to the common system ground plane.   |  |



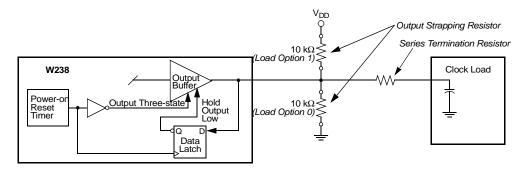


Figure 1. Input Logic Selection Through Resistor Load Option

#### Overview

The W238 is a highly integrated frequency timing generator, supplying all the required clock sources for an Intel architecture platform using graphics integrated core logic.

### **Functional Description**

#### I/O Pin Operation

REF/SEL1 is a dual-purpose I/O pin. Upon power-up the pin acts as a logic input. CPU clock outputs will be determined by the status of FSEL0:1 input pins. An external 10-k $\Omega$  strapping resistor should be used. Figure 1 shows a suggested method for strapping resistor connections.

After 2 ms, the pin becomes an output. Assuming the power supply has stabilized by then, the specified output frequency is delivered on the pins. If the power supply has not yet reached full value, output frequency initially may be below target but will increase to target once supply voltage has stabilized. In either case, a short output clock cycle may be produced from the CPU clock outputs when the outputs are enabled.

#### **Pin Selectable Functions**

Table 1 outlines the device functions selectable through Tristate# and FSEL0:1. Specific outputs available at each pin are detailed in Table 2 below.

Table 2. CK Solano Truth Table

| Tristate# | FSEL1 | FSEL0 | CPU     | SDRAM   | 3V66   | PCI     | 48MHz  | REF        | APIC    | Notes   |
|-----------|-------|-------|---------|---------|--------|---------|--------|------------|---------|---------|
| 0         | Х     | 0     | Hi-Z    | Hi-Z    | Hi-Z   | Hi-Z    | Hi-Z   | Hi-Z       | Hi-Z    | 1       |
| 0         | Х     | 1     | TCLK/4  | TCLK/4  | TCLK/6 | TCLK/12 | TCLK/2 | TCLK       | TCLK/12 | 2, 3    |
| 1         | 0     | 0     | 66 MHz  | 100 MHz | 66 MHz | 33 MHz  | 48 MHz | 14.318 MHz | 33 MHz  | 4, 5, 6 |
| 1         | 0     | 1     | 100 MHz | 100 MHz | 66 MHz | 33 MHz  | 48 MHz | 14.318 MHz | 33 MHz  | 4, 5, 6 |
| 1         | 1     | 1     | 133 MHz | 133MHz  | 66 MHz | 33 MHz  | 48 MHz | 14.318 MHz | 33 MHz  | 1, 3, 5 |
| 1         | 1     | 1     | 133 MHz | 100 MHz | 66 MHz | 33 MHz  | 48 MHz | 14.318 MHz | 33 MHz  | 1, 3, 5 |

- Provided for board-level "bed of nails" testing. TCLK is a test clock overdriven on the XTAL\_IN input during test mode.
- Required for DC output impedance verification. "Normal" mode of operation.
- Range of reference frequency allowed is min. = 14.316 MHz, nominal = 14.31818 MHz, max. = 14.32 MHz. Frequency accuracy of 48 MHz must be +167 PPM to match USB default.



#### How to use PD# input to support VTT\_PWRGD

The PD# input can be used to support the VTT\_PWRGD signal specified in the Intel VRM 8.5 specification. The VTT\_PWRGD is used to indicated that the frequency select output pins (BSEL[0:1]) from the CPU are valid and the clock generator can use them to determine the CPU FSB frequency. The assertion of PD# input pin during initial power-up will delay

the start of the PLL, keep all the multiplexed I/O pins as input and keep all the output inactive. The functionality of PD# will allow the system designer to use this input to support the VTT\_PWRGD output from the VRM 8.5 module. Please refer to the *Figure 2* for power-up sequence details.

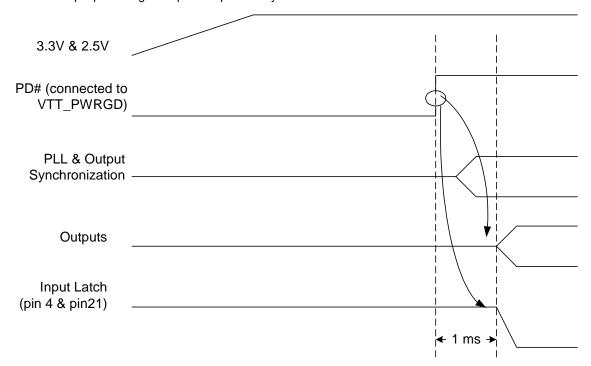


Figure 2. Power-up sequence with PD# (VTT\_PWRGD) hold LOW



#### Offsets Among Clock Signal Groups

Figure 3 and Figure 4 represent the phase relationship among the different groups of clock outputs from W238 when it is providing a 66-MHz CPU clock and a 100-MHz CPU clock, re-

spectively. It should be noted that when CPU clock is operating at 100 MHz, CPU clock output is 180 degrees out of phase with SDRAM clock outputs.

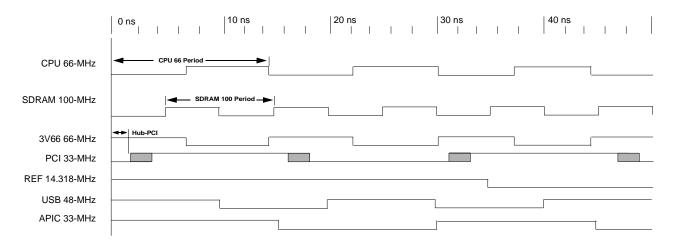


Figure 3. Group Offset Waveforms (66-MHz CPU/100-MHz SDRAM)

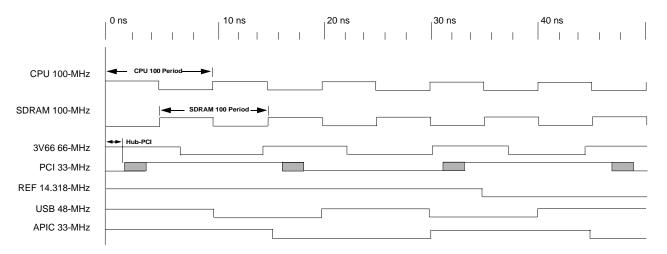


Figure 4. Group Offset Waveforms (100-MHz CPU/100-MHz SDRAM)



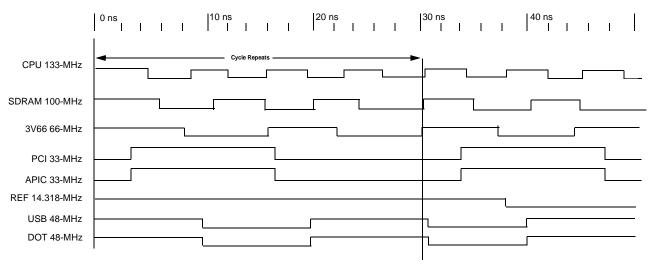


Figure 5. Group Offset Waveforms (133-MHz CPU/100-MHz SDRAM)

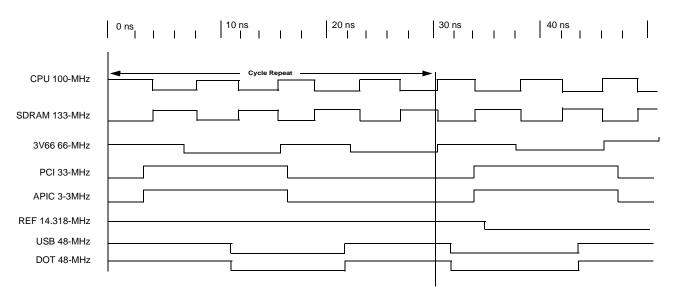


Figure 6. Group Offset Waveform (133-MHz CPU/133-MHz SDRAM)



#### **Power Down Control**

W238 provides one PWRDWN# signal to place the device in low-power mode. In low-power mode, the PLLs are turned off and all clock outputs are driven LOW.

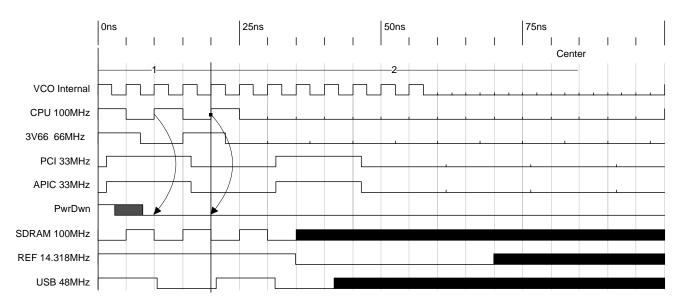


Figure 7. W238 PWRDWN# Timing Diagram<sup>[7, 8, 9, 10]</sup>

Table 3. W238 Maximum Allowed Current

| W238<br>Condition                                    | Max. 2.5V supply consumption Max. discrete cap loads, V <sub>DDQ2</sub> = 2.625V All static inputs = V <sub>DDQ3</sub> or V <sub>SS</sub> | Max. 3.3V supply consumption Max. discrete cap loads V <sub>DDQ3</sub> = 3.465V All static inputs = V <sub>DDQ3</sub> or V <sub>SS</sub> |
|--|---|--|
| Powerdown Mode<br>(PWRDWN# = 0)                      | 100 μΑ  | 500 μΑ   |
| Full Active 66 MHz<br>FSEL1:0 = 00 (PWRDWN# =1)      | 30 mA   | 280 mA   |
| Full Active 100 MHz<br>FSEL1:0 = 01 (PWRDWN# =1)     | 40 mA   | 280 mA   |
| Full Active 133 MHz<br>FSEL1:0 = 10, 11 (PWRDWN# =1) | 50 mA   | 400 mA   |

- Once the PWRDWN# signal is sampled LOW for two consecutive rising edges of CPU, clocks of interest will be held LOW on the next HIGH-to-LOW transition. PWRDWN# is an asynchronous input and metastable conditions could exist. This signal is synchronized inside W238. The shaded sections on the SDRAM, REF, and USB clocks indicate "Don't Care" states. Diagrams shown with respect to 100 MHz. Similar operation when CPU is 66 MHz.
- 8. 9.



### **Spread Spectrum Frequency Timing Generator**

The device generates a clock that is frequency modulated in order to increase the bandwidth that it occupies. By increasing the bandwidth of the fundamental and its harmonics, the amplitudes of the radiated electromagnetic emissions are reduced. This effect is depicted in *Figure 8*.

As shown in *Figure 8*, a harmonic of a modulated clock has a much lower amplitude than that of an unmodulated signal. The reduction in amplitude is dependent on the harmonic number and the frequency deviation or spread. The equation for the reduction is:

$$dB = 6.5 + 9*log_{10}(P) + 9*log_{10}(F)$$

Where P is the percentage of deviation and F is the frequency in MHz where the reduction is measured.

The output clock is modulated with a waveform depicted in *Figure 9*. This waveform, as discussed in "Spread Spectrum Clock Generation for the Reduction of Radiated Emissions" by Bush, Fessler, and Hardin, produces the maximum reduction in the amplitude of radiated electromagnetic emissions. The deviation selected for this chip is –0.5% of the selected frequency. *Figure 9* details the Cypress spreading pattern. Cypress does offer options with more spread and greater EMI reduction. Contact your local Sales representative for details on these devices.

Spread Spectrum clocking is activated or deactivated by selecting the appropriate value for bit 3 in data byte 0 of the SMBus data stream. Refer to page 10 for more details.

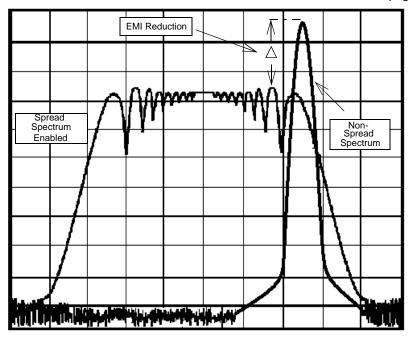


Figure 8. Clock Harmonic with and without SSCG Modulation Frequency Domain Representation

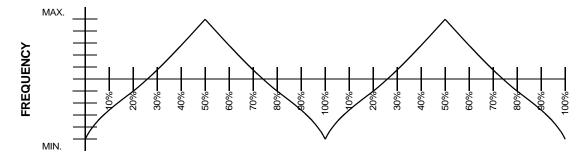


Figure 9. Typical Modulation Profile



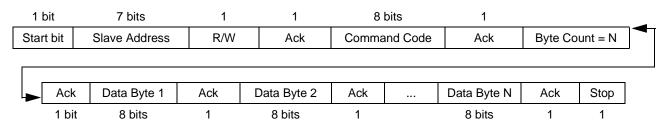


Figure 10. An Example of a Block Write<sup>[11]</sup>

#### **Serial Data Interface**

The W238 features a two-pin, serial data interface that can be used to configure internal register settings that control particular device functions.

#### **Data Protocol**

The clock driver serial protocol accepts only block writes from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. Indexed bytes are not allowed.

A block write begins with a slave address and a write condition. After the command code the core logic issues a byte count which describes how many more bytes will follow in the message. If the host had 20 bytes to send, the first byte would be the number 20 (14h), followed by the 20 bytes of data. The byte count may not be 0. A block write command is allowed to trans-

fer a maximum of 32 data bytes. The slave receiver address for W238 is 11010010. *Figure 10* shows an example of a block write.

The command code and the byte count bytes are required as the first two bytes of any transfer. W238 expects a command code of 0000 0000. The byte count byte is the number of additional bytes required for the transfer, not counting the command code and byte count bytes. Additionally, the byte count byte is required to be a minimum of 1 byte and a maximum of 32 bytes to satisfy the above requirement. *Table 4* shows an example of a possible byte count value.

A transfer is considered valid after the acknowledge bit corresponding to the byte count is read by the controller. The command code and byte count bytes are ignored by the W238. However, these bytes must be included in the data write sequence to maintain proper byte allocation.

Table 4. Example of Possible Byte Count Value

| Byte Co | unt Byte | Notes  |
|---------|----------|--|
| MSB     | LSB      |  |
| 0000    | 0000     | Not allowed. Must have at least one byte                                     |
| 0000    | 0001     | Data for functional and frequency select register (currently byte 0 in spec) |
| 0000    | 0010     | Reads first two bytes of data. (byte 0 then byte 1)                          |
| 0000    | 0011     | Reads first three bytes (byte 0, 1, 2 in order)                              |
| 0000    | 0100     | Reads first four bytes (byte 0, 1, 2, 3 in order)                            |
| 0000    | 0101     | Reads first five bytes (byte 0, 1, 2, 3, 4 in order) <sup>[12]</sup>         |
| 0000    | 0110     | Reads first six bytes (byte 0, 1, 2, 3, 4, 5 in order) <sup>[12]</sup>       |
| 0000    | 0111     | Reads first seven bytes (byte 0, 1, 2, 3, 4, 5, 6 in order)                  |
| 0010    | 0000     | Max. byte count supported = 32   |

Table 5. Serial Data Interface Control Functions Summary

| able 5. Ochai Bata interface Control i unctions Cammary |   |   |  |  |  |  |
|---|---|---|--|--|--|--|
| Control Function  | Description   | Common Application  |  |  |  |  |
| Output Disable  | Any individual clock output(s) can be disabled. Disabled outputs are actively held LOW. | Unused outputs are disabled to reduce EMI and system power. Examples are clock outputs to unused PCI slots. |  |  |  |  |
| Spread Spectrum<br>Enabling                             | Enables or disables spread spectrum clocking.   | For EMI reduction.  |  |  |  |  |
| (Reserved)  | Reserved function for future device revision or production device testing.              | No user application. Register bit must be written as 0.   |  |  |  |  |

The acknowledgment bit is returned by the slave/receiver (W238).

<sup>12.</sup> Data Bytes 3 to 7 are reserved.



### **W238 Serial Configuration Map**

1. The serial bits will be read by the clock driver in the following order:

Byte 0 - Bits 7, 6, 5, 4, 3, 2, 1, 0

Byte 1 - Bits 7, 6, 5, 4, 3, 2, 1, 0

Byte N - Bits 7, 6, 5, 4, 3, 2, 1, 0

- 2. All unused register bits (reserved and N/A) should be written to a "0" level.
- 3. All register bits labeled "Initialize to 0" must be written to zero during initialization. Failure to do so may result in higher than normal operating current. The controller will read back the written value.

Byte 0: Control Register (1 = Enable, 0 = Disable)<sup>[13]</sup>

| Bit   | Pin# | Name  | Default | Pin Function       |
|-------|------|---|---------|--------------------|
| Bit 7 | -    | Reserved  | 0       | Reserved           |
| Bit 6 | -    | Reserved  | 0       | Reserved           |
| Bit 5 | -    | Reserved  | 0       | Reserved           |
| Bit 4 | -    | Reserved  | 0       | Reserved           |
| Bit 3 | -    | Spread Spectrum<br>(1 = On/0 = Off) <sup>[14]</sup> | 0       | (Disabled/Enabled) |
| Bit 2 | 29   | DOT   | 1       | (Active/Inactive)  |
| Bit 1 | 28   | USB   | 1       | (Active/Inactive)  |
| Bit 0 | -    | Reserved  | 0       | Reserved           |

Byte 1: Control Register (1 = Enable, 0 = Disable)[13]

| Bit   | Pin# | Name   | Default | Pin Description   |
|-------|------|--------|---------|-------------------|
| Bit 7 | 40   | SDRAM7 | 1       | (Active/Inactive) |
| Bit 6 | 41   | SDRAM6 | 1       | (Active/Inactive) |
| Bit 5 | 44   | SDRAM5 | 1       | (Active/Inactive) |
| Bit 4 | 45   | SDRAM4 | 1       | (Active/Inactive) |
| Bit 3 | 46   | SDRAM3 | 1       | (Active/Inactive) |
| Bit 2 | 47   | SDRAM2 | 1       | (Active/Inactive) |
| Bit 1 | 50   | SDRAM1 | 1       | (Active/Inactive) |
| Bit 0 | 51   | SDRAM0 | 1       | (Active/Inactive) |

Notes:

Byte 2: Control Register (1 = Enable, 0 = Disable)

| Bit   | Pin# | Name     | Default | Pin Description   |
|-------|------|----------|---------|-------------------|
| Bit 7 | 12   | 3V66_AGP | 1       | (Active/Inactive) |
| Bit 6 | 31   | SDRAM12  | 1       | (Active/Inactive) |
| Bit 5 | 34   | SDRAM11  | 1       | (Active/Inactive) |
| Bit 4 | 35   | SDRAM10  | 1       | (Active/Inactive) |
| Bit 3 | 38   | SDRAM9   | 1       | (Active/Inactive) |
| Bit 2 | 39   | SDRAM8   | 1       | (Active/Inactive) |
| Bit 1 | 15   | PCI1     | 1       | (Active/Inactive) |
| Bit 0 |      | Reserved | 1       | (Active/Inactive) |

 <sup>13.</sup> Inactive means outputs are held LOW and are disabled from switching. These outputs are designed to be configured at power-on and are not expected to be configured during the normal modes of operation.
 14. Spread Spectrum percentage is -0.5%.



Byte 3: Reserved Register (1 = Enable, 0 = Disable)

| Bit   | Pin# | Name   | Default | Pin Description              |
|-------|------|--|---------|------------------------------|
| Bit 7 | -    | Reserved   | 0       | Reserved                     |
| Bit 6 | -    | Reserved   | 0       | Reserved                     |
| Bit 5 | -    | Reserved   | 0       | Reserved                     |
| Bit 4 | -    | Reserved   | 0       | Reserved                     |
| Bit 3 |      | Reserved   | 0       | Reserved                     |
| Bit 2 |      | Reserved   | 0       | Reserved                     |
| Bit 1 | 30   | PWRDWN#/<br>TRISTATE#                                | 1       | 1 = PWRDWN#<br>0 = TRISTATE# |
| Bit 0 |      | SDRAM 133 Mode Enable<br>Disabled ='0', Enabled ='1' | 0       | (Disabled/Enabled)           |

### Byte 4: Reserved Register (1 = Enable, 0 = Disable)

| Bit   | Pin# | Name     | Default | Pin Function    |
|-------|------|----------|---------|-----------------|
| Bit 7 | -    | Reserved | 0       | Reserved        |
| Bit 6 | -    | Reserved | 0       | Reserved        |
| Bit 5 | -    | Reserved | 0       | Reserved        |
| Bit 4 | -    | Reserved | 0       | Reserved        |
| Bit 3 | -    | Reserved | 0       | Reserved        |
| Bit 2 | 20   | PCI4     | 1       | Active/Inactive |
| Bit 1 | 19   | PCI3     | 1       | Active/Inactive |
| Bit 0 | 16   | PCI2     | 1       | Active/Inactive |

### Byte 5: Reserved Register (1 = Enable, 0 = Disable)

| Bit   | Pin# | Name     | Default | Pin Description |
|-------|------|----------|---------|-----------------|
| Bit 7 | -    | Reserved | 0       | Reserved        |
| Bit 6 | -    | Reserved | 0       | Reserved        |
| Bit 5 | -    | Reserved | 0       | Reserved        |
| Bit 4 | -    | Reserved | 0       | Reserved        |
| Bit 3 | -    | Reserved | 0       | Reserved        |
| Bit 2 | -    | Reserved | 0       | Reserved        |
| Bit 1 | -    | Reserved | 0       | Reserved        |
| Bit 0 | -    | Reserved | 0       | Reserved        |

### Byte 6: Reserved Register (1 = Enable, 0 = Disable)

| Bit   | Pin# | Name     | Default | Pin Description |
|-------|------|----------|---------|-----------------|
| Bit 7 | -    | Reserved | 0       | Reserved        |
| Bit 6 | -    | Reserved | 0       | Reserved        |
| Bit 5 | -    | Reserved | 0       | Reserved        |
| Bit 4 | -    | Reserved | 0       | Reserved        |
| Bit 3 | -    | Reserved | 0       | Reserved        |
| Bit 2 | -    | Reserved | 0       | Reserved        |
| Bit 1 | -    | Reserved | 0       | Reserved        |
| Bit 0 | -    | Reserved | 0       | Reserved        |

Document #: 38-07103 Rev. \*\*



# **DC Electrical Characteristics**

### **Absolute Maximum DC Power Supply**

| Parameter        | Description              | Min. | Max. | Unit |
|------------------|--------------------------|------|------|------|
| V <sub>DD3</sub> | 3.3V Core Supply Voltage | -0.5 | 4.6  | V    |
| $V_{DDQ2}$       | 2.5V I/O Supply Voltage  | -0.5 | 3.6  | V    |
| $V_{DDQ3}$       | 3.3V Supply Voltage      | -0.5 | 4.6  | V    |
| T <sub>S</sub>   | Storage Temperature      | -65  | 150  | °C   |

#### Absolute Maximum DC I/O

| Parameter        | Description             | Min. | Max. | Unit |
|------------------|-------------------------|------|------|------|
| V <sub>ih3</sub> | 3.3V Input High Voltage | -0.5 | 4.6  | V    |
| V <sub>il3</sub> | 3.3V Input Low Voltage  | -0.5 |      | V    |
| ESD prot.        | Input ESD Protection    | 2000 |      | V    |

### **DC Operating Requirements**

| Parameter                 | Description                           | Condition                             | Min.                  | Тур. | Max.                  | Unit |
|---------------------------|---------------------------------------|---------------------------------------|-----------------------|------|-----------------------|------|
| $V_{DD3}$                 | 3.3V Core Supply Voltage              | 3.3V ±5%                              | 3.135                 |      | 3.465                 | V    |
| $V_{\rm DDQ3}$            | 3.3V I/O Supply Voltage               | 3.3V ±5%                              | 3.135                 |      | 3.465                 | V    |
| $V_{\rm DDQ2}$            | 2.5V I/O Supply Voltage               | 2.5V ±5%                              | 2.375                 |      | 2.625                 | V    |
| $V_{DD3} = 3.3V \pm 5\%$  |                                       |                                       |                       |      |                       |      |
| V <sub>ih3</sub>          | 3.3V Input High Voltage               | V <sub>DD3</sub>                      | 2.0                   |      | V <sub>DD</sub> + 0.3 | V    |
| V <sub>il3</sub>          | 3.3V Input Low Voltage                |                                       | V <sub>SS</sub> - 0.3 |      | 0.8                   | V    |
| I <sub>il</sub>           | Input Leakage Current <sup>[15]</sup> | 0 <v<sub>in<v<sub>DD3</v<sub></v<sub> | -5                    |      | +5                    | μΑ   |
| $V_{DDQ2} = 2.5V \pm 5\%$ |                                       |                                       |                       |      |                       |      |
| V <sub>oh2</sub>          | 2.5V Output High Voltage              | $I_{oh} = (-1 \text{ mA})$            | 2.0                   |      |                       | V    |
| V <sub>ol2</sub>          | 2.5V Output Low Voltage               | I <sub>ol</sub> = (1 mA)              |                       |      | 0.4                   | V    |
| $V_{DDQ3} = 3.3V \pm 5\%$ |                                       |                                       |                       |      |                       |      |
| V <sub>oh3</sub>          | 3.3V Output High Voltage              | $I_{oh} = (-1 \text{ mA})$            | 2.4                   |      |                       | V    |
| V <sub>ol3</sub>          | 3.3V Output Low Voltage               | I <sub>ol</sub> = (1 mA)              |                       |      | 0.4                   | V    |
| $V_{DDQ3} = 3.3V \pm 5\%$ |                                       |                                       |                       |      |                       |      |
| V <sub>poh3</sub>         | PCI Bus Output High Voltage           | $I_{oh} = (-1 \text{ mA})$            | 2.4                   |      |                       | V    |
| V <sub>pol3</sub>         | PCI Bus Output Low Voltage            | I <sub>ol</sub> = (1 mA)              |                       |      | 0.55                  | V    |
|                           |                                       |                                       |                       |      |                       |      |
| C <sub>in</sub>           | Input Pin Capacitance                 |                                       |                       |      | 5                     | pF   |
| C <sub>xtal</sub>         | Xtal Pin Capacitance                  |                                       | 13.5                  |      | 22.5                  | pF   |
| C <sub>out</sub>          | Output Pin Capacitance                |                                       |                       |      | 6                     | pF   |
| L <sub>pin</sub>          | Pin Inductance                        |                                       | 0                     |      | 7                     | nΗ   |
| T <sub>a</sub>            | Ambient Temperature                   | No Airflow                            | 0                     |      | 70                    | °C   |

<sup>15.</sup> Input Leakage Current does not include inputs with pull-up or pull-down resistors.



# **DC Operating Requirements** (continued)

| Parameter       | Description         | Description |                         | Min. | Тур. | Max. | Unit |
|-----------------|---------------------|-------------|-------------------------|------|------|------|------|
| I <sub>OL</sub> | Output Low Current  | PCI0:7      | V <sub>OL</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | REF2X/FS3   | V <sub>OL</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | 48 MHz      | V <sub>OL</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | 24 MHz      | V <sub>OL</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | SDRAM0:12   | V <sub>OL</sub> = 1.5V  | 60   | 100  | 160  | mA   |
|                 |                     | CPU0:1      | $V_{OL} = 1.25V$        | 25   | 50   | 95   | mA   |
| I <sub>OH</sub> | Output High Current | PCI0:7      | V <sub>OH</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | REF2X/FS3   | V <sub>OH</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | 48 MHz      | V <sub>OH</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | 24 MHz      | V <sub>OH</sub> = 1.5V  | 20   | 40   | 90   | mA   |
|                 |                     | SDRAM0:12   | V <sub>OH</sub> = 1.5V  | 60   | 100  | 160  | mA   |
|                 |                     | CPU0:1      | V <sub>OH</sub> = 1.25V | 25   | 50   | 95   | mA   |



#### **AC Electrical Characteristics**

 $T_A$  = 0°C to +70°C,  $V_{DDQ3}$  = 3.3V ±5%,  $V_{DDQ2}$ = 2.5V ±5%  $f_{XTL}$  = 14.31818 MHz Spread Spectrum function turned off

AC clock parameters are tested and guaranteed over stated operating conditions using the stated lump capacitive load at the clock output.<sup>[16]</sup>

|                                       |                                       | 66.6-M | Hz Host | 100-MI | dz Host | 133-MI | Iz Host |      |        |
|---------------------------------------|---------------------------------------|--------|---------|--------|---------|--------|---------|------|--------|
| Parameter                             | Description                           | Min.   | Max.    | Min.   | Max.    | Min.   | Max.    | Unit | Notes  |
| T <sub>Period</sub>                   | Host/CPUCLK Period                    | 15.0   | 15.5    | 10.0   | 10.5    | 7.5    | 8.0     | ns   | 16     |
| T <sub>HIGH</sub>                     | Host/CPUCLK High Time                 | 5.2    | N/A     | 3.0    | N/A     | 1.87   | N/A     | ns   | 17     |
| T <sub>LOW</sub>                      | Host/CPUCLK Low Time                  | 5.0    | N/A     | 2.8    | N/A     | 1.67   | N/A     | ns   | 18     |
| T <sub>RISE</sub>                     | Host/CPUCLK Rise Time                 | 0.4    | 1.6     | 0.4    | 1.6     | 0.4    | 1.6     | ns   |        |
| T <sub>FALL</sub>                     | Host/CPUCLK Fall Time                 | 0.4    | 1.6     | 0.4    | 1.6     | 0.4    | 1.6     | ns   |        |
| T <sub>Period</sub>                   | SDRAM CLK Period                      | 10.0   | 10.5    | 10.0   | 10.5    | 10.0   | 10.5    | ns   | 16     |
| T <sub>HIGH</sub> SDRAM CLK High Time |                                       | 3.0    | N/A     | 3.0    | N/A     | 3.0    | N/A     | ns   | 17     |
| T <sub>LOW</sub>                      | SDRAM CLK Low Time                    | 2.8    | N/A     | 2.8    | N/A     | 2.8    | N/A     | ns   | 18     |
| T <sub>RISE</sub>                     | SDRAM CLK Rise Time                   | 0.4    | 1.6     | 0.4    | 1.6     | 0.4    | 1.6     | ns   |        |
| T <sub>FALL</sub>                     | SDRAM CLK Fall Time                   | 0.4    | 1.6     | 0.4    | 1.6     | 0.4    | 1.6     | ns   |        |
| T <sub>Period</sub>                   | APIC 33-MHz CLK Period                | 30.0   | N/A     | 30.0   | N/A     | 30.0   | N/A     | ns   | 16     |
| T <sub>HIGH</sub>                     | APIC 33-MHz CLK High Time             | 12.0   | N/A     | 12.0   | N/A     | 12.0   | N/A     | ns   | 17     |
| T <sub>LOW</sub>                      |                                       |        | N/A     | 12.0   | N/A     | 12.0   | N/A     | ns   | 18     |
| T <sub>RISE</sub>                     | APIC CLK Rise Time                    | 0.4    | 1.6     | 0.4    | 1.6     | 0.4    | 1.6     | ns   |        |
| T <sub>FALL</sub>                     | APIC CLK Fall Time                    | 0.4    | 1.6     | 0.4    | 1.6     | 0.4    | 1.6     | ns   |        |
| T <sub>Period</sub>                   | 3V66 CLK Period                       | 15.0   | 16.0    | 15.0   | 16.0    | 15.0   | 16.0    | ns   | 16, 19 |
| T <sub>HIGH</sub>                     | 3V66 CLK High Time                    | 5.25   | N/A     | 5.25   | N/A     | 5.25   | N/A     | ns   | 17     |
| T <sub>LOW</sub>                      | 3V66 CLK Low Time                     | 5.05   | N/A     | 5.05   | N/A     | 5.05   | N/A     | ns   | 18     |
| T <sub>RISE</sub>                     | 3V66 CLK Rise Time                    | 0.5    | 2.0     | 0.5    | 2.0     | 0.5    | 2.0     | ns   |        |
| T <sub>FALL</sub>                     | 3V66 CLK Fall Time                    | 0.5    | 2.0     | 0.5    | 2.0     | 0.5    | 2.0     | ns   |        |
| T <sub>Period</sub>                   | PCI CLK Period                        | 30.0   | N/A     | 30.0   | N/A     | 30.0   | N/A     | ns   | 16, 20 |
| T <sub>HIGH</sub>                     | PCI CLK High Time                     | 12.0   | N/A     | 12.0   | N/A     | 12.0   | N/A     | ns   | 17     |
| T <sub>LOW</sub>                      | PCI CLK Low Time                      | 12.0   | N/A     | 12.0   | N/A     | 12.0   | N/A     | ns   | 18     |
| T <sub>RISE</sub>                     | PCI CLK Rise Time                     | 0.5    | 2.0     | 0.5    | 2.0     | 0.5    | 2.0     | ns   |        |
| T <sub>FALL</sub>                     | PCI CLK Fall Time                     | 0.5    | 2.0     | 0.5    | 2.0     | 0.5    | 2.0     | ns   |        |
| tp <sub>ZL</sub> , tp <sub>ZH</sub>   | Output Enable Delay (All outputs)     | 1.0    | 10.0    | 1.0    | 10.0    | 1.0    | 10.0    | ns   |        |
| tp <sub>LZ</sub> , tp <sub>ZH</sub>   | Output Disable Delay<br>(All outputs) | 1.0    | 10.0    | 1.0    | 10.0    | 1.0    | 10.0    | ns   |        |
| t <sub>stable</sub>                   | All Clock Stabilization from Power-Up |        | 3       |        | 3       |        | 3       | ms   |        |

Period, jitter, offset, and skew measured on rising edge at 1.25 for 2.5V clocks and at 1.5V for 3.3V clocks.
 The time specified is measured from when V<sub>DDQ3</sub> achieves its nominal operating level (typical condition V<sub>DDQ3</sub> = 3.3V) until the frequency output is stable and operating within specification.
 T<sub>RISE</sub> and T<sub>FALL</sub> are measured as a transition through the threshold region V<sub>ol</sub> = 0.4V and V<sub>oh</sub> = 2.0V (1 mA) JEDEC specification.

T<sub>LOW</sub> is measured at 0.4V for all outputs.
 T<sub>HIGH</sub> is measured at 2.0V for 2.5V outputs, 2.4V for 3.3V outputs.



### **Group Skew and Jitter Limits**

| Output Group | Pin-Pin Skew<br>Max. | Cycle-Cycle<br>Jitter | Duty Cycle | Nom Vdd | Skew, Jitter<br>Measure Point | Typical Output Impedance           |
|--------------|----------------------|-----------------------|------------|---------|-------------------------------|------------------------------------|
| CPU          | 175 ps               | 250 ps                | 45/55      | 2.5V    | 1.25V                         | 31Ω                                |
| SDRAM        | 250 ps               | 250 ps                | 45/55      | 3.3V    | 1.5V                          | 22Ω                                |
| APIC         | 250 ps               | 500 ps                | 45/55      | 2.5V    | 1.25V                         | 21Ω                                |
| 48MHz        | 250 ps               | 500 ps                | 45/55      | 3.3V    | 1.5V                          | USB 31 $\Omega$<br>Dot 22 $\Omega$ |
| 3V66         | 175 ps               | 500 ps                | 45/55      | 3.3V    | 1.5V                          | 31Ω                                |
| PCI          | 500 ps               | 500 ps                | 45/55      | 3.3V    | 1.5V                          | 31Ω                                |
| REF          | N/A                  | 1000 ps               | 45/55      | 3.3V    | 1.5V                          | 21Ω                                |

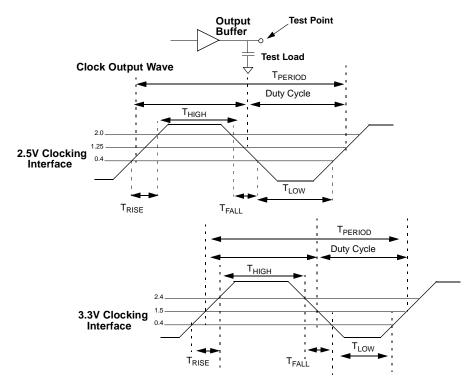


Figure 11. Output Buffer

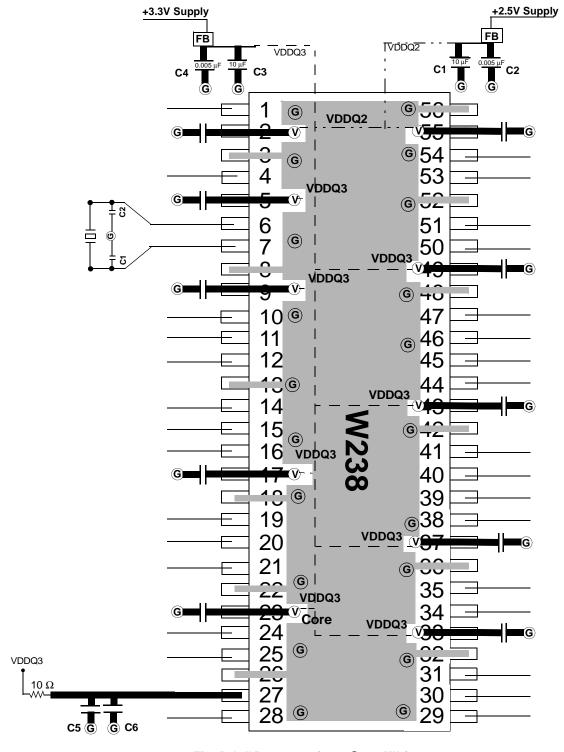
# **Ordering Information**

| Ordering Code | Package Name | Package Type           |
|---------------|--------------|------------------------|
| W238-02       | Н            | 56-pin SSOP (300 mils) |

Intel is a registered trademark of Intel Corporation



### **Layout Diagram**



FB = Dale ILB1206 - 300 (300 $\Omega$  @ 100 MHz)

Ceramic Caps C1 & C3 = 10–22  $\,\mu F$  C2 & C4 = 0.005  $\,\mu F$  C5 = 10  $\,\mu F$  C6 = 0.1  $\,\mu F$ 

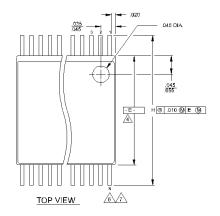
 $\bigcirc$  = VIA to GND plane layer  $\bigcirc$  =VIA to respective supply plane layer

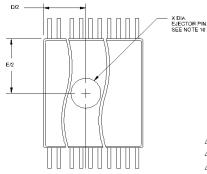
Note: Each supply plane or strip should have a ferrite bead and capacitors



#### **Package Diagram**

#### 56-Pin Shrink Small Outline Package (SSOP, 300 mils)

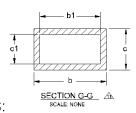




BOTTOM VIEW

SEE DETAIL A

END VIEW



### NOTES:

- MAXIMUM DIE THICKNESS ALLOWABLE IS .025.
- DIMENSIONING & TOLERANCING PER ANSI
- À DIMENSIONING & TOLERANCING PER ANSI

  Y14.5M 1982.

  ↑ "T" IS A REFERENCE DATUM.

  ↑ "D" & "E" ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DOES INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE MOLD PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED. 006 INCHES PER SIDE.

  ↑ "L" IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE.

  ↑ "IN" IS THE NUMBER OF TERMINAL POSITIONS.

  ↑ TERMINAL POSITIONS ARE CHUMAL FOR

- TERMINAL POSITIONS ARE SHOWN FOR REFERENCE ONLY.

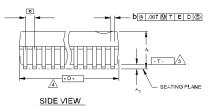
- REFERENCE ONLY

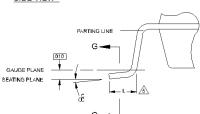
  8 FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN 003 INCHES AT SEATING PLANE.

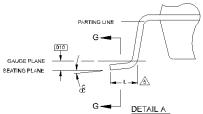
  10 COUNTRY OF ORIGIN LOCATION AND EJECTOR PIN ON PACKAGE BOTTOM IS OPTIONAL AND DEPENDS ON ASSEMBLY LOCATION.

  11 THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 INCHES AND .010 INCHES FROM THE LEAD TIPS.

  12 THIS PART IS COMPILIANT WITH JEDEC SPECIFICATION MO-118, VARIATIONS AA, AB, EXCEPT CHAMFER DIMENSION h, JEDEC SPECIFICATION FOR h IS .015"/.025".









Body Width: 0.296 Lead Pitch: 0.025 Body Length: 0.625 Body Height: 0.102

| S.             |      | COMMO     |       |                 | NOTE   |           | 4       |        | 6          |
|----------------|------|-----------|-------|-----------------|--------|-----------|---------|--------|------------|
| M B            | D    | IMENSIO   | NS    | K <sub>II</sub> | VARI-  | D         |         |        | N          |
| 1 9            | MIN. | NOM.      | MAX.  | 1.              | ATIONS | MIN.      | NOM.    | MAX.   |            |
| Α              | .095 | .102      | .110  |                 | AA     | .620      | .625    | .630   | 48         |
| A <sub>1</sub> | .008 | .012      | .016  |                 | AB     | .720      | .725    | .730   | 56         |
| A.             | .088 | .090      | .092  |                 |        |           |         |        |            |
| ь              | .008 | .010      | .0135 |                 |        | <b>T.</b> |         |        |            |
| b              | .008 | .010      | .012  |                 |        | THIS      | TABLE I | N INCH | <b>-</b> S |
| С              | .005 | -         | .010  |                 |        |           |         |        |            |
| C <sub>1</sub> | .005 | .006      | .0085 |                 |        |           |         |        |            |
| D              | SEE  | VARIATION | is    | 4               |        |           |         |        |            |
| E              | .292 | .296      | .299  |                 |        |           |         |        |            |
| е              |      | .025 BSC  |       |                 |        |           |         |        |            |
| Н              | .400 | .406      | .410  |                 |        |           |         |        |            |
| h              | .010 | .013      | .016  |                 |        |           |         |        |            |
| L              | .024 | .032      | .040  |                 |        |           |         |        |            |
| N              | SEE  | VARIATION | IS    | 6               |        |           |         |        |            |
| χ              | .085 | .093      | .100  | 10              |        |           |         |        |            |
| œ              | 0°   | 5°        | 8°    |                 |        |           |         |        |            |
| _              |      |           |       |                 |        |           |         |        |            |

| S.      |                | COMMO     | V     |     | NOTE                       |       | 4     |       | 6  |  |
|---------|----------------|-----------|-------|-----|----------------------------|-------|-------|-------|----|--|
| M<br>B  | D              | IMENSIOI  | NS .  | No. | VARI-                      | D     |       |       | N  |  |
| 2       | MIN.           | NOM.      | MAX.  | 'E  | ATIONS                     | MIN.  | NOM.  | MAX.  |    |  |
| Α       | 2.41           | 2.59      | 2.79  |     | AA                         | 15.75 | 15.88 | 16.00 | 48 |  |
| A,      | 0.20           | 0.31      | 0.41  |     | AB                         | 18.29 | 18.42 | 18.54 | 56 |  |
| A,      | 2.24           | 2.29      | 2.34  |     |                            |       |       |       |    |  |
| b       | 0.203          | 0.254     | 0.343 |     | T. 110 T. D. E. 111 L. 114 |       |       |       |    |  |
| b₁      | 0.203          | 0.254     | 0.305 |     | THIS TABLE IN MILLIMETI    |       |       |       |    |  |
| С       | 0.127          | -         | 0.254 |     |                            |       |       |       |    |  |
| Cı      | 0.127          | 0.152     | 0.216 |     |                            |       |       |       |    |  |
| D       | SEE            | VARIATION |       | 4   |                            |       |       |       |    |  |
| E       | 7.42           | 7.52      | 7.59  |     |                            |       |       |       |    |  |
| е       |                | 0.635 BSC |       |     |                            |       |       |       |    |  |
| H       | 10.16          | 10.31     | 10.41 |     |                            |       |       |       |    |  |
| h       | 0.25           | 0.33      | 0.41  |     |                            |       |       |       |    |  |
| L       | 0.61           | 0.81      | 1.02  |     |                            |       |       |       |    |  |
| N       | SEE VARIATIONS |           |       | 6   |                            |       |       |       |    |  |
| X<br>df | 2.16           | 2.36      | 2.54  | 10  |                            |       |       |       |    |  |
| ď       | 0°             | 5°        | 8°    |     | ]                          |       |       |       |    |  |



| Document Title: W238-02 FTG for Integrated Core Logic w/ 133 MHz FSB Document Number: 38-07103 |         |               |                 |                       |
|--|---------|---------------|-----------------|-----------------------|
| REV.   | ECN NO. | Issue<br>Date | Orig. of Change | Description of Change |
| **   | 107459  | 08/08/01      | IKA             | New Data Sheet        |